Technical Data Sheet

0603 Package Chip LED (0.8mm Height)

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS complaint version.

Descriptions

- The 19-21 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

	Chip		Resin Color	
Part No.	Material	Emitted Color		
19-21/R6C-AP1Q2/3T	AlGaInP	Brilliant Red	Water Clear	

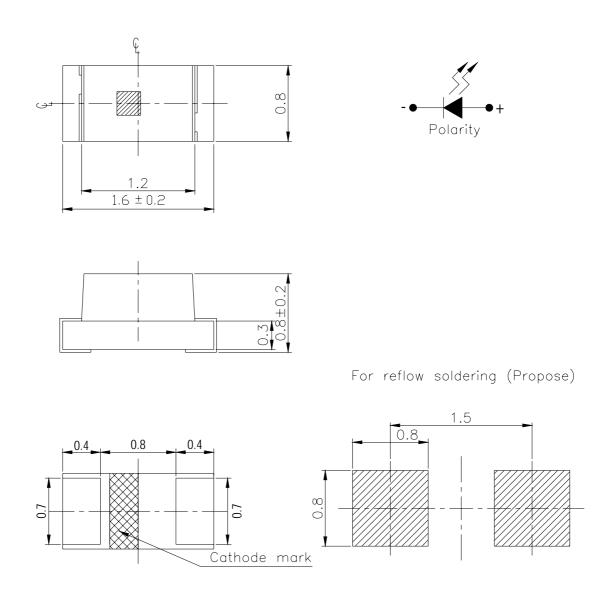


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Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

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LIGHTING

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Absolute Maximum Katings (1a–25 C)					
Parameter	Symbol	Rating	Unit		
Reverse Voltage	Vr	5	V		
Forward Current	$I_{ m F}$	25	mA		
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA		
Power Dissipation	Pd	60	mW		
Electrostatic Discharge(HBM)	ESD	2000	V		
Operating Temperature	Topr	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +90	°C		
Soldering Temperature	Tsol	Reflow Soldering : $260 \degree$ Cfor 10 secHand Soldering : $350 \degree$ Cfor 3 sec.			

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	I _V	45.0		112	mcd		
Viewing Angle	2 0 1/2		100		deg		
Peak Wavelength	λp		632		nm		
Dominant Wavelength	λd	617.5		633.5	nm	I _F =20mA	
Spectrum Radiation Bandwidth	$ riangle \lambda$		20		nm		
Forward Voltage	V_{F}	1.7	2.0	2.4	V		
Reverse Current	I _R			10	μA	V _R =5V	

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm



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Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
A	E4	617.5	621.5		I 20 A
	E5	621.5	625.5	nm	
	E6	625.5	629.5		$I_F = 20 m A$
	E7	629.5	633.5		

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
P1	45.0	57.0	mcd	I _F =20mA
P2	57.0	72.0		
Q1	72.0	90.0		
Q2	90.0	112		

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

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Typical Electro-Optical Characteristics Curves Spectrum Distribution Forward Currentivs. Forward Voltage Tæ=25°C Ta=25°C 50 100 B Forward Current , I (mA) Relative luminous intensity 40 75 1 30 1 25 50 20 25 10 0 0 1.2 1.6 2.0 2.4 2.8 3.0 500 550 600 650 700 Forward Voltage V, (V) Wavelength λ (nm) Luminous Intensity vs Luminous Intensity vs. Forward Current Ambient Temperature Ta=25°C ළි₁₀₀₀ E 1000 TRH Relative luminous intensity Relative luminous intensity utv=1/10 100 100 10 10 1 1 10 10 10 . -60 -40 -20 0 20 40 60 80 100 Ambient Temperature Ta (°C) Forward Current I, (mA) Radiation Diagram Ta=25°C Forward Current Derating Curve 0° 10° 20° 50 30° l_f(mA) 40 40° Forward Current 30 1.0 25 0.9 50° 20 0.8 60° 10 70° 0.7 80° 0 L 0 90° 20 60 100 40 85 0.3 0.1 0.2 0.4 0.6 0.5 Ambient Temperature Ta (°C)

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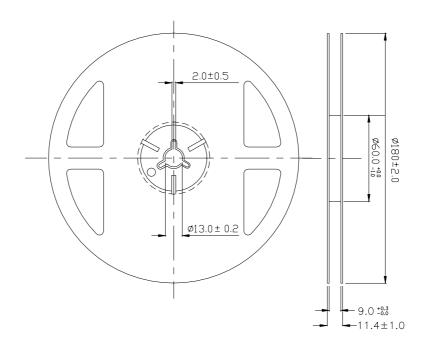


Label explanation

- **CAT: Luminous Intensity Rank**
- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**



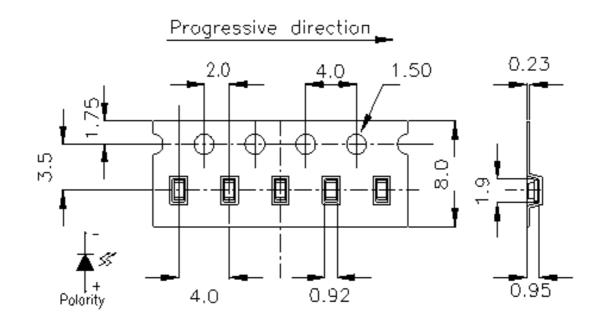
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm , Unit = mm

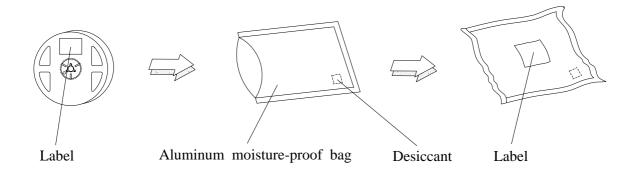


<u>19-21/R6C-AP1Q2/3T</u> Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min $\int 5 \text{ min}$ L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1



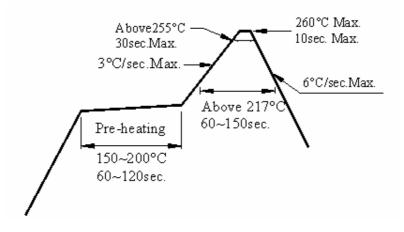
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Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90% RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.



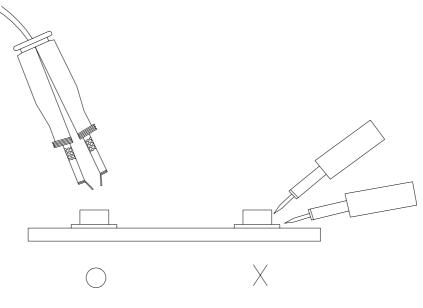
19-21/R6C-AP1Q2/3T

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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